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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	2375
Number of Logic Elements/Cells	19000
Total RAM Bits	1246208
Number of I/O	140
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m20e-5fn256i

July 2012

Data Sheet DS1006

Features

- **High Logic Density for System Integration**
 - 6K to 95K LUTs
 - 90 to 583 I/Os
- **Embedded SERDES (LatticeECP2M Only)**
 - Data Rates 250 Mbps to 3.125 Gbps
 - Up to 16 channels per device
 - PCI Express, Ethernet (1GbE, SGMII), OBSAI, CPRI and Serial RapidIO.
- **sysDSP™ Block**
 - 3 to 42 blocks for high performance multiply and accumulate
 - Each block supports
 - One 36x36, four 18x18 or eight 9x9 multipliers
- **Flexible Memory Resources**
 - 55Kbits to 530Kbits sysMEM™ Embedded Block RAM (EBR)
 - 18Kbit block
 - Single, pseudo dual and true dual port
 - Byte Enable Mode support
 - 12K to 202Kbits distributed RAM
 - Single port and pseudo dual port
- **sysCLOCK Analog PLLs and DLLs**
 - Two GPLLS and up to six SPLLLs per device
 - Clock multiply, divide, phase & delay adjust
 - Dynamic PLL adjustment
 - Two general purpose DLLs per device

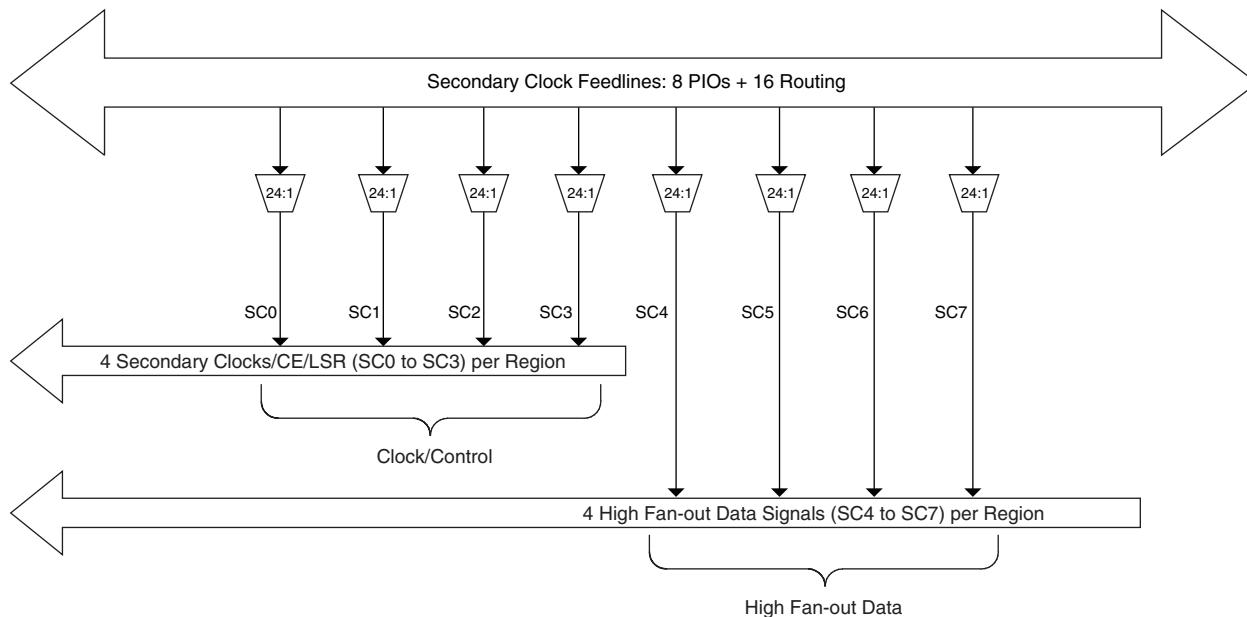
- **Pre-Engineered Source Synchronous I/O**
 - DDR registers in I/O cells
 - Dedicated gearing logic
 - Source synchronous standards support
 - SPI4.2, SFI4 (DDR Mode), XGMII
 - High Speed ADC/DAC devices
 - Dedicated DDR and DDR2 memory support
 - DDR1: 400 (200MHz) / DDR2: 533 (266MHz)
 - Dedicated DQS support
- **Programmable sysI/O™ Buffer Supports Wide Range Of Interfaces**
 - LVTTL and LVCMSO 33/25/18/15/12
 - SSTL 3/2/18 I, II
 - HSTL15 I and HSTL18 I, II
 - PCI and Differential HSTL, SSTL
 - LVDS, RSDS, Bus-LVDS, MLVDS, LVPECL
- **Flexible Device Configuration**
 - 1149.1 Boundary Scan compliant
 - Dedicated bank for configuration I/Os
 - SPI boot flash interface
 - Dual boot images supported
 - TransFR™ I/O for simple field updates
 - Soft Error Detect macro embedded
- **Optional Bitstream Encryption (LatticeECP2/M “S” Versions Only)**
- **System Level Support**
 - ispTRACY™ internal logic analyzer capability
 - On-chip oscillator for initialization & general use
 - 1.2V power supply

Table 1-1. LatticeECP2 (Including “S-Series”) Family Selection

Device	ECP2-6	ECP2-12	ECP2-20	ECP2-35	ECP2-50	ECP2-70
LUTs (K)	6	12	21	32	48	68
Distributed RAM (Kbits)	12	24	42	64	96	136
EBR SRAM (Kbits)	55	221	276	332	387	1032
EBR SRAM Blocks	3	12	15	18	21	60
sysDSP Blocks	3	6	7	8	18	22
18x18 Multipliers	12	24	28	32	72	88
GPLL + SPLLL + DLL	2+0+2	2+0+2	2+0+2	2+0+2	2+2+2	2+4+2
Maximum Available I/O	190	297	402	450	500	583
Packages and I/O Combinations						
144-pin TQFP (20 x 20 mm)	90	93				
208-pin PQFP (28 x 28 mm)		131	131			
256-ball fpBGA (17 x 17 mm)	190	193	193			
484-ball fpBGA (23 x 23 mm)		297	331	331	339	
672-ball fpBGA (27 x 27 mm)			402	450	500	500
900-ball fpBGA (31 x 31 mm)						583

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Figure 2-16. Secondary Clock Selection



Slice Clock Selection

Figure 2-17 shows the clock selections and Figure 2-18 shows the control selections for Slice0 through Slice2. All the primary clocks and the four secondary clocks are routed to this clock selection mux. Other signals can be used as a clock input to the slices via routing. Slice controls are generated from the secondary clocks or other signals connected via routing.

If none of the signals are selected for both clock and control then the default value of the mux output is 1. Slice 3 does not have any registers; therefore it does not have the clock or control muxes.

Figure 2-17. Slice0 through Slice2 Clock Selection

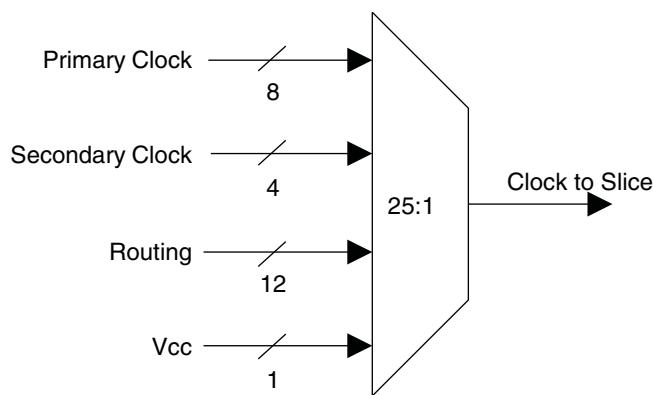
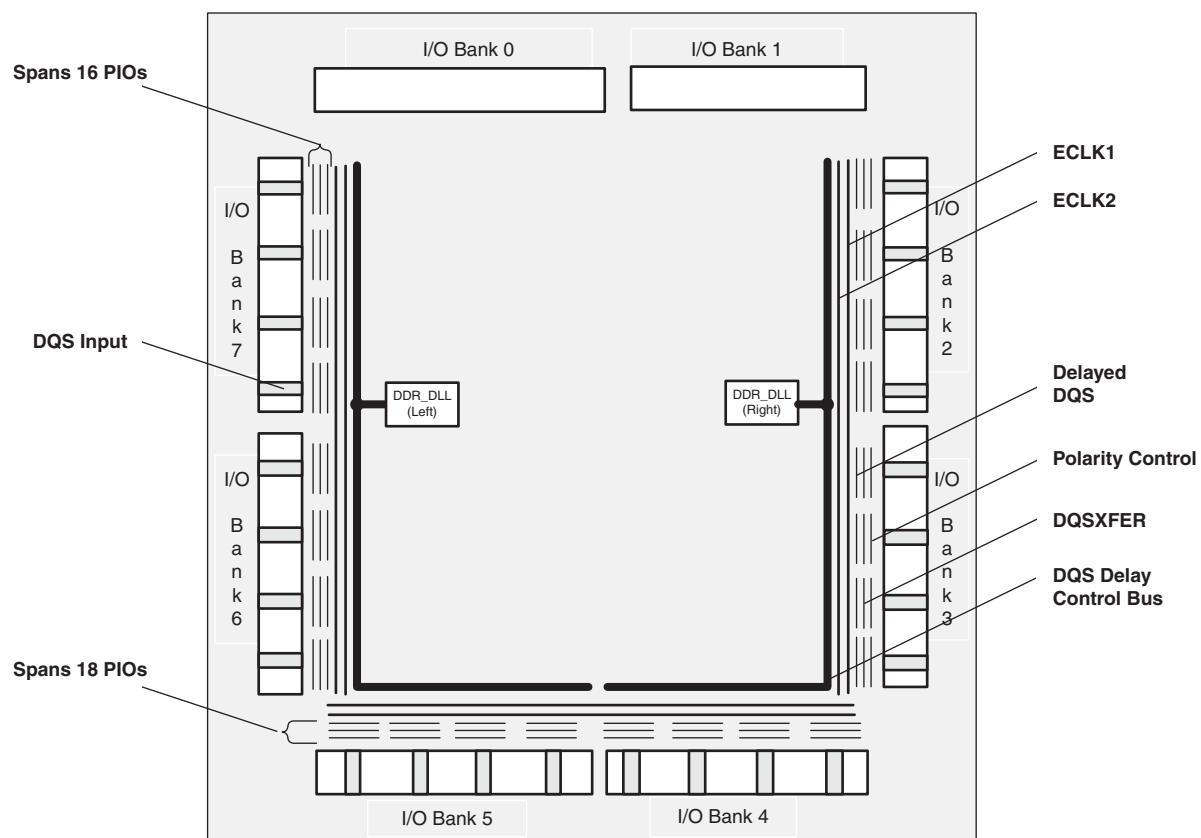
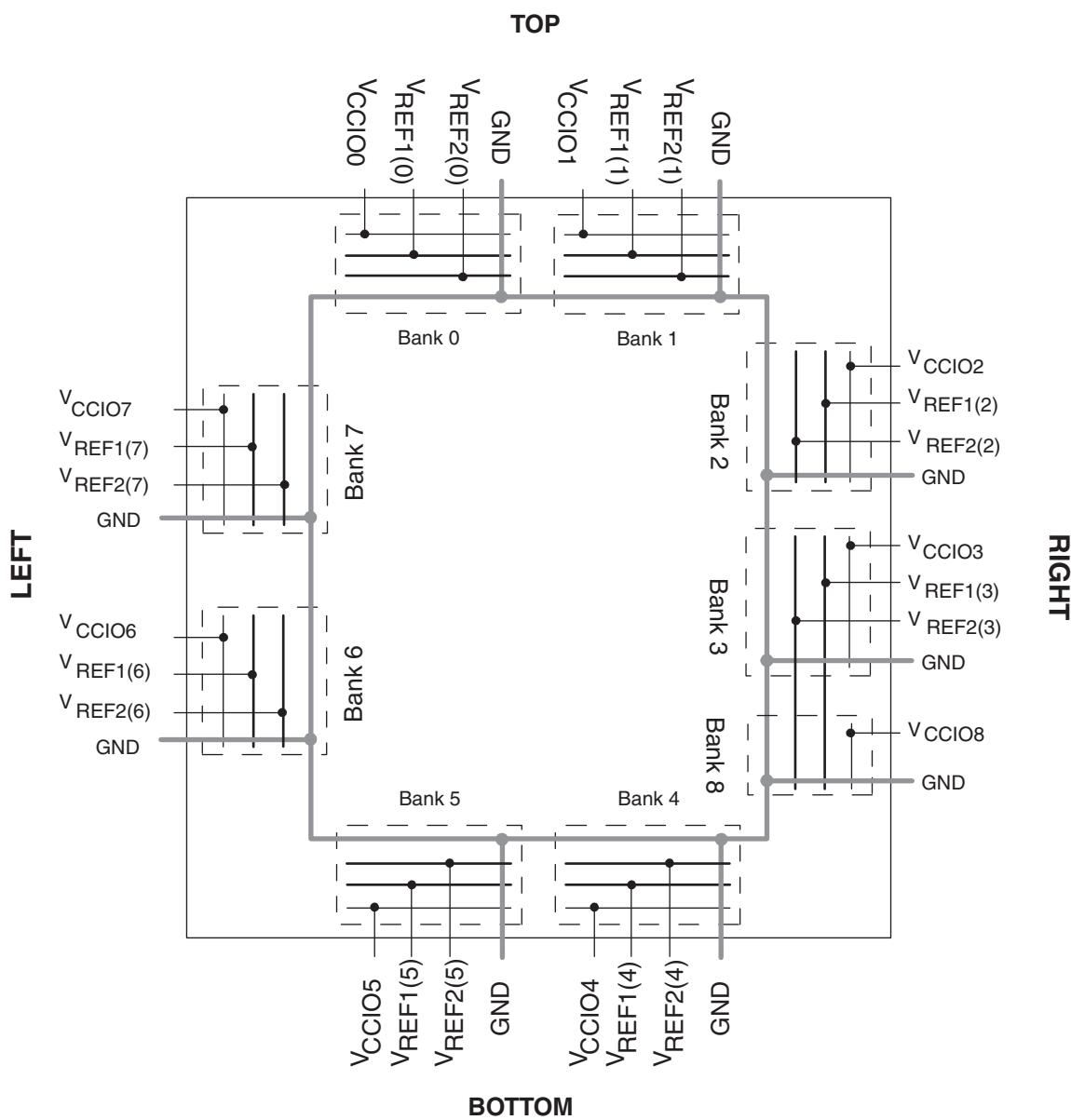


Figure 2-35. Edge Clock, DLL Calibration and DQS Local Bus Distribution



Note: Bank 8 is not shown.

Figure 2-37. LatticeECP2 Banks



SERDES Power Supply Requirements (LatticeECP2M Family Only)¹

Over Recommended Operating Conditions

Symbol	Description	Typ. ²	Units
Standby (Power Down)			
I _{CCTX-SB}	V _{CCTX} current (per channel)	10	µA
I _{CCRX-SB}	V _{CCRX} current (per channel)	75	µA
I _{CCIB-SB}	Input buffer current (per channel)	0	µA
I _{CCOB-SB}	Output buffer current (per channel)	0	µA
I _{CCP-SB}	SERDES PLL current (per quad)	30	µA
I _{CCAX33-SB}	SERDES termination current (per quad)	10	µA
Operating (Data Rate = 3.125 Gbps)			
I _{CCTX-OP}	V _{CCTX} current (per channel)	19	mA
I _{CCRX-OP}	V _{CCRX} current (per channel)	34	mA
I _{CCIB-OP}	Input buffer current (per channel)	4	mA
I _{CCOB-OP}	Output buffer current (per channel)	13	mA
I _{CCP-OP}	SERDES PLL current (per quad)	26	mA
I _{CCAX33-OP}	SERDES termination current (per quad)	0.01	mA

1. Equalization enabled, pre-emphasis disabled.

2. T_J = 25°C, power supplies at nominal voltage.

SERDES Power (LatticeECP2M Family Only)

Table 3-1 presents the SERDES power for one channel.

Table 3-1. SERDES Power¹

Symbol	Description	Typ. ²	Units
P _{S-1CH-31}	SERDES power (one channel @ 3.125 Gbps)	90	mW
P _{S-1CH-25}	SERDES power (one channel @ 2.5 Gbps)	87	mW
P _{S-1CH-12}	SERDES power (one channel @ 1.25 Gbps)	86	mW
P _{S-1CH-02}	SERDES power (one channel @ 250 Mbps)	76	mW

1. One quarter of the total quad power (includes contribution from common circuits, all channels in the quad operating, pre-emphasis disabled, equalization enabled).

2. Typical values measured at 25°C and 1.2V.

sysI/O Differential Electrical Characteristics

LVDS

Over Recommended Operating Conditions

Parameter	Description	Test Conditions	Min.	Typ.	Max.	Units
V_{INP} , V_{INM}	Input Voltage		0	—	2.4	V
V_{CM}	Input Common Mode Voltage	Half the Sum of the Two Inputs	0.05	—	2.35	V
V_{THD}	Differential Input Threshold	Difference Between the Two Inputs	+/-100	—	—	mV
I_{IN}	Input Current	Power On or Power Off	—	—	+/-10	μ A
V_{OH}	Output High Voltage for V_{OP} or V_{OM}	$R_T = 100$ Ohm	—	1.38	1.60	V
V_{OL}	Output Low Voltage for V_{OP} or V_{OM}	$R_T = 100$ Ohm	0.9V	1.03	—	V
V_{OD}	Output Voltage Differential	$(V_{OP} - V_{OM})$, $R_T = 100$ Ohm	250	350	450	mV
ΔV_{OD}	Change in V_{OD} Between High and Low		—	—	50	mV
V_{OS}	Output Voltage Offset	$(V_{OP} + V_{OM})/2$, $R_T = 100$ Ohm	1.125	1.20	1.375	V
ΔV_{OS}	Change in V_{OS} Between H and L		—	—	50	mV
I_{SA}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Ground	—	—	24	mA
I_{SAB}	Output Short Circuit Current	$V_{OD} = 0V$ Driver Outputs Shorted to Each Other	—	—	12	mA

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
t_{SU_DEPLLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
t_{H_DEPLLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns

DDR I/O Pin Parameters²

t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR}	DDR Clock Frequency ⁶	ECP2/M	95	200	95	166	95	133	MHz

DDR2 I/O Pin Parameters³

t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]_SQ_VCCIBm	—	Input buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_VCCOBm	—	Output buffer power supply, channel m (1.2V/1.5V). This pin should be left floating if the channel is unused.
[LOC]_SQ_HDOUTNm	O	High-speed output, negative channel m
[LOC]_SQ_HDOUTPm	O	High-speed output, positive channel m
[LOC]_SQ_HDINNm	I	High-speed input, negative channel m
[LOC]_SQ_HDINPm	I	High-speed input, positive channel m
[LOC]_SQ_VCCTXm ⁴	—	Transmitter power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.
[LOC]_SQ_VCCR Xm ⁴	—	Receiver power supply, channel m (1.2V). This pin must be tied to 1.2V even if the channel is unused.

1. These signals are relevant for LatticeECP2M family.
2. m defines the associated channel in the Quad.
3. These signals are defined in Quads [LOC] indicates the corner SERDES Quad is located: ULC (upper left), URC (upper right), LLC (lower left), LRC (lower right).
4. When placing switching I/Os around these critical pins that are designed to supply the device with the proper reference or supply voltage, care must be given. For more information, refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#).
5. There may be SPLLs that do not have dedicated I/Os.

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35

Pin Type	LFE2-20				LFE2-35	
	208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O	131	193	331	402	331	450
Differential Pair User I/O	62	96	165	200	165	224
Configuration	TAP Pins	5	5	5	5	5
	Muxed Pins	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7
Non Configuration	Muxed Pins	42	54	60	64	60
	Dedicated Pins	3	3	3	3	3
VCC	14	7	18	24	16	22
VCCAUX	8	4	16	16	16	16
VCCPLL	0	0	0	0	2	2
VCCIO	Bank0	2	2	4	5	4
	Bank1	2	2	4	5	4
	Bank2	2	2	4	5	4
	Bank3	2	2	4	5	4
	Bank4	2	2	4	5	4
	Bank5	2	2	4	5	4
	Bank6	2	2	4	5	4
	Bank7	2	2	4	5	4
	Bank8	2	1	2	2	2
GND, GND0 to GND7	22	20	60	72	60	72
NC	0	1	8	101	8	102
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	18/9	18/9	50/25	67/33	50/25
	Bank1	18/9	34/17	46/23	52/26	46/23
	Bank2	11/5	20/10	34/17	36/18	34/17
	Bank3	11/5	12/6	22/11	32/16	22/11
	Bank4	19/9	32/16	46/23	50/25	46/23
	Bank5	18/9	17/8	46/23	68/34	46/23
	Bank6	18/8	26/13	40/20	48/24	40/20
	Bank7	12/6	20/10	33/16	35/17	33/16
	Bank8	6/2	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0
	Bank2 (Right Edge)	4	5	9	9	12
	Bank3 (Right Edge)	3	3	5	8	5
	Bank4 (Bottom Edge)	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0
	Bank6 (Left Edge)	6	7	10	12	10
	Bank7 (Left Edge)	5	5	8	8	11
	Bank8 (Right Edge)	0	0	0	0	0

LatticeECP2 Power Supply and NC (Cont.)

Signals	672 fpBGA ³	900 fpBGA ³
VCC	LFE2-20: R8, P18, M8, L20, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-35/LFE2-50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2-70: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	AA11, AA20, K11, K21, K22, L11, L12, L13, L18, L19, L20, M11, M20, N11, N20, V11, V20, W11, W20, Y10, Y11, Y12, Y13, Y18, Y19, Y20
VCCIO0	D11, D6, G9, J12, K12	J13, J14, K12, K13, K14, K15
VCCIO1	D16, D21, G18, J15, K15	J17, J18, J20, K17, K18, K20
VCCIO2	F23, J20, L23, M17, M18	L21, M21, M22, N21, N22, R21
VCCIO3	AA23, R17, R18, T23, V20	U21, U22, V21, V22, W21, Y22
VCCIO4	AC16, AC21, U15, V15, Y18	AA16, AA17, AA18, AA19, AB17, AB18
VCCIO5	AC11, AC6, U12, V12, Y9	AA12, AA13, AA14, AB12, AB13, AB14
VCCIO6	AA4, R10, R9, T4, V7	U10, U9, V10, W10, W9, Y9
VCCIO7	F4, J7, L4, M10, M9	L10, L9, M10, N10, P10, R10
VCCIO8	AE25, V18	AA21, Y21
VCCJ	AB5	AD3
VCCAUX	J10, J11, J16, J17, K18, L18, T18, U18, V16, V17, V10, V11, T9, U9, K9, L9	AA15, AB11, AB19, AB20, J11, J12, J19, K19, L22, M9, N9, P21, P9, T10, T21, V9, W22
VCCPLL	LFE2-20: None LFE2-35/LFE2-70: R8, P18 LFE2-50: R8, P18, M8, L20	P22, P8, T22, Y7
GND ¹	A2, A25, AA18, AA24, AA3, AA9, AD11, AD16, AD21, AD6, AE1, AE26, AF2, AF25, B1, B26, C11, C16, C21, C6, F18, F24, F3, F9, J13, J14, J21, J6, K10, K11, K13, K14, K16, K17, L10, L11, L16, L17, L24, L3, M13, M14, N10, N12, N13, N14, N15, N17, P10, P12, P13, P14, P15, P17, R13, R14, T10, T11, T16, T17, T24, T3, U10, U11, U13, U14, U16, U17, V13, V14, V21, V6	A1, A30, AC28, AC3, AH13, AH18, AH23, AH28, AH3, AH8, AK1, AK30, C13, C18, C23, C28, C3, C8, H28, H3, L14, L15, L16, L17, M12, M13, M14, M15, M16, M17, M18, M19, N12, N13, N14, N15, N16, N17, N18, N19, N28, N3, P11, P12, P13, P14, P15, P16, P17, P18, P19, P20, R11, R12, R13, R14, R15, R16, R17, R18, R19, R20, T11, T12, T13, T14, T15, T16, T17, T18, T19, T20, U11, U12, U13, U14, U15, U16, U17, U18, U19, U20, V12, V13, V14, V15, V16, V17, V18, V19, V28, V3, W12, W13, W14, W15, W16, W17, W18, W19, Y14, Y15, Y16, Y17
NC ²	LFE2-20: E4, E3, E2, E1, H6, H5, F2, F1, H8, J9, G4, G3, K3, K2, K1, L2, L1, M2, M1, N2, T1, T2, P8, P6, P5, P4, U1, V1, P3, R3, R4, U2, V2, W2, T6, R5, AA19, W17, Y19, Y17, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, R22, T21, P26, P25, R24, R23, P20, R19, P21, P19, P23, P22, N22, R21, N26, N25, J26, J25, J23, K23, H26, H25, H24, H23, F22, E24, D25, C25, D24, B25, H21, G22, B24, C24, D23, C23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-35: K3, K2, K1, L2, L1, M2, M1, N2, M8, P3, R3, R4, U2, V2, W2, AF20, AE20, AA20, W18, AD20, AE21, AF21, AF22, P26, P25, R24, R23, P20, R19, L20, J26, J25, J23, K23, H26, H25, H24, H23, E19, C19, B21, B20, D19, B19, G17, E18, G19, F17, A20, A19, E17, D18, M3, N6, P24 LFE2-50: N6, P24, M3 LFE2-70: M8, L20, M3, P24, N6	A2, A3, A4, A5, AB28, AC4, AD23, AE1, AE2, AE29, AE3, AE30, AE4, AE5, AE6, AF1, AF2, AF23, AF26, AF27, AF28, AF29, AF3, AF30, AF4, AF5, AG1, AG13, AG16, AG18, AG2, AG26, AG27, AG28, AG29, AG3, AG30, AG4, AG8, AH1, AH16, AH2, AH26, AH27, AH29, AH30, AH4, AJ1, AJ2, AJ27, AJ28, AJ29, AJ3, AJ30, AK2, AK27, AK28, AK29, AK3, B1, B2, B3, B30, B4, B5, C1, C2, C29, C30, C4, D13, D18, D23, D28, D29, D3, D30, D4, E25, E26, E27, E28, E29, E3, E30, E4, E5, E6, F25, F5, F6, G6, G7, K10, K9, N27, N4, R1, R2, V27, V4

- All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
- NC pins should not be connected to any active signals, VCC or GND.
- Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
136	PT6B	0		C	PT16B	0		C	
137	PT6A	0		T	PT16A	0		T	
138	GND	-			GND	-			
139	VCCIO0	0			VCCIO0	0			
140	PT4B	0		C	PT6B	0		C	
141	PT4A	0		T	PT6A	0		T	
142	VCCAUX	-			VCCAUX	-			
143	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
144	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for PLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one-to-one connection with a package ball or pin.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GND	GNDIO6	-			GNDIO6	-			
L2	PL24A	6	LDQ28	T (LVDS)*	PL24A	6	LDQ28	T (LVDS)*	
K2	PL25A	6	LDQ28	T	PL25A	6	LDQ28	T	
L3	PL24B	6	LDQ28	C (LVDS)*	PL24B	6	LDQ28	C (LVDS)*	
K1	PL25B	6	LDQ28	C	PL25B	6	LDQ28	C	
VCCIO	VCCIO6	6			VCCIO6	6			
L4	PL26A	6	LDQ28	T (LVDS)*	PL26A	6	LDQ28	T (LVDS)*	
L1	PL27A	6	LDQ28	T	PL27A	6	LDQ28	T	
L5	PL26B	6	LDQ28	C (LVDS)*	PL26B	6	LDQ28	C (LVDS)*	
M1	PL27B	6	LDQ28	C	PL27B	6	LDQ28	C	
GND	GNDIO6	-			GNDIO6	-			
N1	PL29A	6	LDQ28	T	PL29A	6	LDQ28	T	
N2	PL28A	6	LDQS28	T (LVDS)*	PL28A	6	LDQS28	T (LVDS)*	
P1	PL29B	6	LDQ28	C	PL29B	6	LDQ28	C	
VCCIO	VCCIO6	6			VCCIO6	6			
P2	PL28B	6	LDQ28	C (LVDS)*	PL28B	6	LDQ28	C (LVDS)*	
R1	PL30A	6	LDQ28	T (LVDS)*	PL30A	6	LDQ28	T (LVDS)*	
GND	GNDIO6	-			GNDIO6	-			
R2	PL30B	6	LDQ28	C (LVDS)*	PL30B	6	LDQ28	C (LVDS)*	
N4	TDI	-			TDI	-			
M4	TCK	-			TCK	-			
P3	TDO	-			TDO	-			
N3	TMS	-			TMS	-			
K7	VCCJ	-			VCCJ	-			
M5	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
K6	NC	-			PB3A	5	BDQ6		
M6	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
R3	NC	-			PB5A	5	BDQ6	T	
P4	NC	-			PB5B	5	BDQ6	C	
-	-	-			VCCIO	5			
-	-	-			GNDIO5	5			
N5	PB3A	5	BDQ6	T	PB21A	5	BDQ24	T	
N6	PB3B	5	BDQ6	C	PB21B	5	BDQ24	C	
T2	PB4A	5	BDQ6	T	PB22A	5	BDQ24	T	
P6	PB5A	5	BDQ6	T	PB23A	5	BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			
T3	PB4B	5	BDQ6	C	PB22B	5	BDQ24	C	
R6	PB5B	5	BDQ6	C	PB23B	5	BDQ24	C	
GND	GNDIO5	-			GNDIO5	-			
R4	PB6A	5	BDQS6	T	PB24A	5	BDQS24	T	
L6	PB7A	5	BDQ6	T	PB25A	5	BDQ24	T	
T4	PB6B	5	BDQ6	C	PB24B	5	BDQ24	C	
L7	PB7B	5	BDQ6	C	PB25B	5	BDQ24	C	
N7	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T	
VCCIO	VCCIO5	5			VCCIO5	5			

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
W13	PB46A	4	BDQ42	T	PB55A	4	BDQ51	T	
GNDIO	GNDIO4	-			GNDIO4	-			
W14	PB46B	4	BDQ42	C	PB55B	4	BDQ51	C	
AB18	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T	
AB19	PB48B	4	BDQ51	C	PB57B	4	BDQ60	C	
V14	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T	
W15	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C	
VCCIO	VCCIO4	4			VCCIO	4			
Y15	PB50A	4	BDQ51	T	PB59A	4	BDQ60	T	
AA15	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AA16	PB51A	4	BDQS51	T	PB60A	4	BDQS60	T	
AA17	PB51B	4	BDQ51	C	PB60B	4	BDQ60	C	
AB20	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T	
AB21	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C	
U15	PB53A	4	BDQ51	T	PB62A	4	BDQ60	T	
U16	PB53B	4	BDQ51	C	PB62B	4	BDQ60	C	
VCCIO	VCCIO4	4			VCCIO	4			
Y16	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T	
W16	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C	
AA18	PB55A	4	BDQ51	T	PB64A	4	BDQ60	T	
AA20	PB55B	4	BDQ51	C	PB64B	4	BDQ60	C	
GNDIO	GNDIO4	-			GNDIO4	-			
VCCIO	VCCIO4	4			VCCIO	4			
AA21	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T	
AA22	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C	
V16	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T	
V17	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO	4			
Y18	PB68A	4	BDQ69	T	PB77A	4	BDQ78	T	
Y17	PB68B	4	BDQ69	C	PB77B	4	BDQ78	C	
GNDIO	GNDIO4	-			GNDIO4	-			
Y19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T	
Y20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C	
W17	PB70A	4	BDQ69	T	PB79A	4	BDQ78	T	
W18	PB70B	4	BDQ69	C	PB79B	4	BDQ78	C	
Y21	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T	
Y22	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C	
VCCIO	VCCIO4	4			VCCIO	4			
U18	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T	
V18	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C	
T15	PB73A	4	VREF2_4/BDQ69	T	PB82A	4	VREF2_4/BDQ78	T	
T16	PB73B	4	VREF1_4/BDQ69	C	PB82B	4	VREF1_4/BDQ78	C	
GNDIO	GNDIO4	-			GNDIO4	-			
W19	CFG2	8			CFG2	8			
V19	CFG1	8			CFG1	8			

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A3	GND	-			GND	-		
A9	GND	-			GND	-		
B12	GND	-			GND	-		
B6	GND	-			GND	-		
E15	GND	-			GND	-		
E2	GND	-			GND	-		
H14	GND	-			GND	-		
H8	GND	-			GND	-		
H9	GND	-			GND	-		
J3	GND	-			GND	-		
J8	GND	-			GND	-		
J9	GND	-			GND	-		
M15	GND	-			GND	-		
M2	GND	-			GND	-		
P9	GND	-			GND	-		
R12	GND	-			GND	-		
R5	GND	-			GND	-		
T1	GND	-			GND	-		
T16	GND	-			GND	-		
D10	NC	-			NC	-		
D11	NC	-			NC	-		
D12	NC	-			NC	-		
D13	NC	-			NC	-		
D14	NC	-			NC	-		
D4	NC	-			NC	-		
D5	NC	-			NC	-		
D6	NC	-			NC	-		
D7	NC	-			NC	-		
E11	NC	-			NC	-		
E6	NC	-			NC	-		
E8	NC	-			NC	-		
E9	NC	-			NC	-		
F10	NC	-			NC	-		
F7	NC	-			NC	-		
F8	NC	-			NC	-		
F9	NC	-			NC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
P8	PL45A	6	LDQ48	T	PL49A	6	LDQ52	T	
R6	PL45B	6	LDQ48	C	PL49B	6	LDQ52	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T1	PL46A	6	LDQ48	T (LVDS)*	PL50A	6	LDQ52	T*	
U1	PL46B	6	LDQ48	C (LVDS)*	PL50B	6	LDQ52	C*	
R7	PL47A	6	LDQ48	T	PL51A	6	LDQ52	T	
T5	PL47B	6	LDQ48	C	PL51B	6	LDQ52	C	
GNDIO	GNDIO6	-			GNDIO6	-			
U3	PL48A	6	LDQS48	T (LVDS)*	PL52A	6	LDQS52	T*	
U4	PL48B	6	LDQ48	C (LVDS)*	PL52B	6	LDQ52	C*	
U5	PL49A	6	LDQ48	T	PL53A	6	LDQ52	T	
VCCIO	VCCIO6	6			VCCIO6	6			
U6	PL49B	6	LDQ48	C	PL53B	6	LDQ52	C	
U2	PL50A	6	LDQ48	T (LVDS)*	PL54A	6	LDQ52	T*	
V1	PL50B	6	LDQ48	C (LVDS)*	PL54B	6	LDQ52	C*	
W2	PL51A	6	LDQ48	T	PL55A	6	LDQ52	T	
GNDIO	GNDIO6	-			GNDIO6	-			
V2	PL51B	6	LDQ48	C	PL55B	6	LDQ52	C	
V4	PL55A	6	LDQ57	T (LVDS)*	PL59A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
V3	PL55B	6	LDQ57	C (LVDS)*	PL59B	6		C*	
-	-	-			GNDIO6	-			
W4	PL57A	6	LLM0_GPLL_IN_A**/LDQS57****	T (LVDS)*	PL62A	6	LLM0_GPLL_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
W3	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C (LVDS)*	PL62B	6	LLM0_GPLLC_IN_A	C*	
W1	PL58A	6	LLM0_GPLLFB_A/LDQ57	T	PL63A	6	LLM0_GPLLFB_A	T	
Y1	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C	PL63B	6	LLM0_GPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
AA1	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*	PL64A	6	LLM0_GDLLT_IN_A	T*	
AB1	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	PL64B	6	LLM0_GDLLC_IN_A	C*	
U7	PL60A	6	LLM0_GDLLTFB_A/LDQ57	T	PL65A	6	LLM0_GDLLTFB_A	T	
V6	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C	PL65B	6	LLM0_GDLLC_FB_A	C	
GNDIO	GNDIO6	-			GNDIO6	-			
T8	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
W5	PL62A	6	LDQ66	T (LVDS)*	PL67A	6	LDQ71	T*	
Y4	PL62B	6	LDQ66	C (LVDS)*	PL67B	6	LDQ71	C*	
U8	PL63A	6	LDQ66	T	PL68A	6	LDQ71	T	
W6	PL63B	6	LDQ66	C	PL68B	6	LDQ71	C	
VCCIO	VCCIO6	6			VCCIO6	6			
Y3	PL64A	6	LDQ66	T (LVDS)*	PL69A	6	LDQ71	T*	
AA3	PL64B	6	LDQ66	C (LVDS)*	PL69B	6	LDQ71	C*	
V7	NC	-			PL70A	6	LDQ71	T	
Y5	PL65B	6	LDQ66	C	PL70B	6	LDQ71	C	
GNDIO	GNDIO6	-			GNDIO6	-			
AB2	PL66A	6	LDQS66	T (LVDS)*	PL71A	6	LDQS71	T*	
AA4	PL66B	6	LDQ66	C (LVDS)*	PL71B	6	LDQ71	C*	
Y6	PL67A	6	LDQ66	T	PL72A	6	LDQ71	T	
VCCIO	VCCIO6	6			VCCIO6	6			

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C15	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
B15	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
C14	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A18	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
C18	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
B18	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
C17	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
B17	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
A16	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A17	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
C16	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
B14	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B13	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
A14	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
C13	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		
-	-	-			GNDIO1	-		
-	-	-			VCCIO1	1		
E17	PT46B	1		C	PT55B	1		C
D17	PT46A	1		T	PT55A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
F17	PT45B	1		C	PT54B	1		C
D16	PT45A	1		T	PT54A	1		T
F19	PT44B	1		C	PT53B	1		C
F18	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
E16	PT43B	1		C	PT52B	1		C
D15	PT43A	1		T	PT52A	1		T
G18	PT42B	1		C	PT51B	1		C
E15	PT42A	1		T	PT51A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
G17	PT41B	1		C	PT50B	1		C
E14	PT41A	1		T	PT50A	1		T
D14	PT40B	1		C	PT49B	1		C
D13	PT40A	1		T	PT49A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F15	PT39B	1	VREF2_1	C	PT48B	1	VREF2_1	C
E12	PT39A	1	VREF1_1	T	PT48A	1	VREF1_1	T
H17	PT38B	1	PCLKC1_0	C	PT47B	1	PCLKC1_0	C
E13	PT38A	1	PCLKT1_0	T	PT47A	1	PCLKT1_0	T
C12	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	-		
G15	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T
C11	PT36B	0	VREF2_0	C	PT45B	0	VREF2_0	C
F14	PT36A	0	VREF1_0	T	PT45A	0	VREF1_0	T

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
A12	PT35B	0		C	PT44B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
A11	PT35A	0		T	PT44A	0			T
D12	PT34B	0		C	PT43B	0			C
H16	PT34A	0		T	PT43A	0			T
H18	PT33B	0		C	PT42B	0			C
H15	PT33A	0		T	PT42A	0			T
A10	PT32B	0		C	PT41B	0			C
GNDIO	GNDIO0	-			GNDIO0	-			
B10	PT32A	0		T	PT41A	0			T
D11	PT31B	0		C	PT40B	0			C
VCCIO	VCCIO0	0			VCCIO0	0			
G14	PT31A	0		T	PT40A	0			T
E11	PT30B	0		C	PT39B	0			C
F13	PT30A	0		T	PT39A	0			T
D10	PT29B	0		C	PT38B	0			C
H14	PT29A	0		T	PT38A	0			T
GNDIO	GNDIO0	-			GNDIO0	-			
VCCIO	VCCIO0	0			VCCIO0	0			
A9	PT24B	0		C	PT24B	0			C
C10	PT23B	0		C	PT23B	0			C
GNDIO	GNDIO0	-			GNDIO0	-			
E8	PT23A	0		T	PT23A	0			T
B9	PT22B	0		C	PT22B	0			C
A8	PT22A	0		T	PT22A	0			T
VCCIO	VCCIO0	0			VCCIO0	0			
F12	PT21B	0		C	PT21B	0			C
E10	PT21A	0		T	PT21A	0			T
G13	PT20B	0		C	PT20B	0			C
C9	PT20A	0		T	PT20A	0			T
B8	PT19B	0		C	PT19B	0			C
GNDIO	GNDIO0	-			GNDIO0	-			
A7	PT19A	0		T	PT19A	0			T
D9	PT18B	0		C	PT18B	0			C
H13	PT18A	0		T	PT18A	0			T
D6	PT17B	0		C	PT17B	0			C
C7	PT17A	0		T	PT17A	0			T
VCCIO	VCCIO0	0			VCCIO0	0			
C8	PT16B	0		C	PT16B	0			C
G12	PT16A	0		T	PT16A	0			T
D8	PT15B	0		C	PT15B	0			C
H12	PT15A	0		T	PT15A	0			T
GNDIO	GNDIO0	-			GNDIO0	-			
A6	PT14B	0		C	PT14B	0			C
A5	PT14A	0		T	PT14A	0			T
A4	PT13B	0		C	PT13B	0			C
A3	PT13A	0		T	PT13A	0			T
VCCIO	VCCIO0	0			VCCIO0	0			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AB27	PR97A	3	RDQ99	T (LVDS)*
VCCIO	VCCIO3	3		
Y24	PR96B	3	RDQ99	C
Y25	PR96A	3	RDQ99	T
AA29	PR95B	3	RDQ99	C (LVDS)*
Y28	PR95A	3	RDQ99	T (LVDS)*
Y30	PR93B	3	RDQ90	C
Y29	PR93A	3	RDQ90	T
GNDIO	GNDIO3	-		
VCCIO	VCCIO3	3		
W22	PR83B	3	RDQ81	C (LVDS)*
V22	PR83A	3	RDQ81	T (LVDS)*
Y27	PR82B	3	RDQ81	C
VCCIO	VCCIO3	3		
Y26	PR82A	3	RDQ81	T
W30	PR81B	3	RDQ81	C (LVDS)*
W29	PR81A	3	RDQS81	T (LVDS)*
GNDIO	GNDIO3	-		
W25	PR80B	3	RDQ81	C
W26	PR80A	3	RDQ81	T
U29	PR79B	3	RDQ81	C (LVDS)*
V29	PR79A	3	RDQ81	T (LVDS)*
VCCIO	VCCIO3	3		
V30	PR78B	3	RDQ81	C
U30	PR78A	3	RDQ81	T
W27	PR77B	3	RDQ81	C (LVDS)*
W28	PR77A	3	RDQ81	T (LVDS)*
V24	PR75B	3	RDQ72	C
V25	PR75A	3	RDQ72	T
GNDIO	GNDIO3	-		
U28	PR74B	3	RDQ72	C (LVDS)*
U27	PR74A	3	RDQ72	T (LVDS)*
U23	PR73B	3	RDQ72	C
V23	PR73A	3	RDQ72	T
VCCIO	VCCIO3	3		
V26	PR72B	3	RDQ72	C (LVDS)*
U26	PR72A	3	RDQS72	T (LVDS)*
U25	PR71B	3	RDQ72	C
GNDIO	GNDIO3	-		
U24	PR71A	3	RDQ72	T
T30	PR70B	3	RDQ72	C (LVDS)*
R30	PR70A	3	RDQ72	T (LVDS)*
T23	PR69B	3	RDQ72	C



Ordering Information
LatticeECP2/M Family Data Sheet

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20SE-5QN208I	131	1.2V	-5	Lead-Free PQFP	208	Ind	20
LFE2-20SE-6QN208I	131	1.2V	-6	Lead-Free PQFP	208	Ind	20
LFE2-20SE-5FN256I	193	1.2V	-5	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-6FN256I	193	1.2V	-6	Lead-Free fpBGA	256	Ind	20
LFE2-20SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	20
LFE2-20SE-5FN672I	402	1.2V	-5	Lead-Free fpBGA	672	Ind	20
LFE2-20SE-6FN672I	402	1.2V	-6	Lead-Free fpBGA	672	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35SE-5FN484I	331	1.2V	-5	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-6FN484I	331	1.2V	-6	Lead-Free fpBGA	484	Ind	35
LFE2-35SE-5FN672I	450	1.2V	-5	Lead-Free fpBGA	672	Ind	35
LFE2-35SE-6FN672I	450	1.2V	-6	Lead-Free fpBGA	672	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50SE-5FN484I	339	1.2V	-5	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-6FN484I	339	1.2V	-6	Lead-Free fpBGA	484	Ind	50
LFE2-50SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	50
LFE2-50SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70SE-5FN672I	500	1.2V	-5	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-6FN672I	500	1.2V	-6	Lead-Free fpBGA	672	Ind	70
LFE2-70SE-5FN900I	583	1.2V	-5	Lead-Free fpBGA	900	Ind	70
LFE2-70SE-6FN900I	583	1.2V	-6	Lead-Free fpBGA	900	Ind	70



Ordering Information
LatticeECP2/M Family Data Sheet

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5F1152C	520	1.2V	-5	fpBGA	1152	COM	100
LFE2M100E-6F1152C	520	1.2V	-6	fpBGA	1152	COM	100
LFE2M100E-7F1152C	520	1.2V	-7	fpBGA	1152	COM	100
LFE2M100E-5F900C	416	1.2V	-5	fpBGA	900	COM	100
LFE2M100E-6F900C	416	1.2V	-6	fpBGA	900	COM	100
LFE2M100E-7F900C	416	1.2V	-7	fpBGA	900	COM	100